









Release Date: 18 May 2023 Version: A1.0

# PRODUCT DATASHEET



- ► EMC 2-PIN SMD
- ➤ 2016 0.52t
- ► Cool White 5600K

NOW63S70 (High TLCI)





# **2016 EMC Series**





#### **APPLICATIONS:**

- **General Lighting**
- Museum Lighting
- Portable Lighting
- **Commercial Lighting**
- **Indoor Lighting**
- Backlight for LCD

- Package: Top View EMC White Package
- Forward Current: 60mA
- Forward Voltage (typ.): 2.9V
- Luminous Flux (typ.): 21lm@60mA
- Colour: Cool White
- Colour Temperature (CCT): 5600K
- Viewing Angle: 120°
- **Materials:**

**FEATURES:** 

- Die: InGaN
- Resin: Silicon (Yellow Diffused)
- Package: EMC
- Operating Temperature: -40~+105°C
- Storage Temperature: -40~+105°C
- CRI/TLCI (min.): 94/95
  - **Grouping Parameters:** 
    - Forward Voltage
    - Luminous Flux
    - **CIE Chromaticity**
- **Soldering Methods: Reflow Soldering**
- MSL Level: MSL3 according to J-STD020
- Packing: 8mm tape with max.5000/reel, ø165mm (6.5")



# **CHARACTERISTICS:**

# Absolute Maximum Characteristics (Ta=25°C)

Parameter	Symbol	Ratings	Unit
DC Forward Current	I <sub>F</sub>	150	mA
Pulse Forward Current (Duty 1/10, width≤100μS)	I <sub>PF</sub>	225	mA
Power Dissipation	P <sub>D</sub>	480	mW
Reverse Voltage	V <sub>R</sub>	5	٧
Reverse Current @10V	I <sub>R</sub>	10	μΑ
Junction Temperature	T <sub>j</sub>	120	°C
Thermal Resistance (Junction to Solder Point)	R <sub>THJS</sub>	38	°C/W
Operating Temperature	T <sub>OPR</sub>	-40~+105	°C
Storage Temperature	T <sub>STG</sub>	-40~+105	°C
Soldering Temperature	T <sub>SOL</sub>	230/260 for 10S	°C
Colour Rendering Index	CRI	min.94	
Television Lighting Consistency Index	TLCI	min.95	

# Electrical & Optical Characteristics (Ta=25°C)

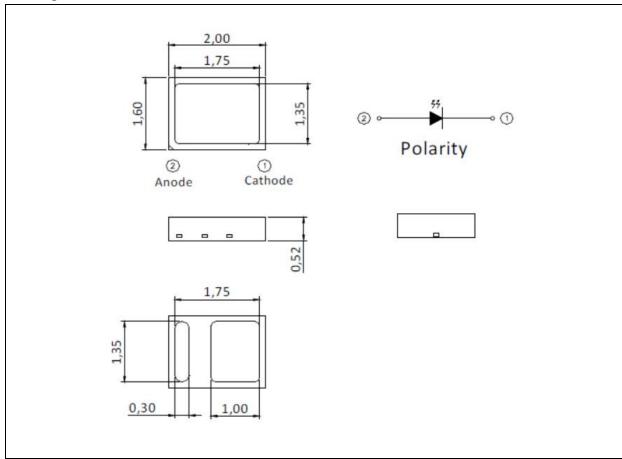
Parameter Symb		Values			Unit	Test	
Parameter	Symbol	Min.	Тур.	Тур. Мах.		Condition	
Forward Voltage	$V_{F}$	2.8	2.9	3.2	V	I <sub>F</sub> =60mA	
Luminous Flux	Ф۷	18	21	24	lm	I <sub>F</sub> =60mA	
Chromaticity Coordinates	Х		0.3287			I <sub>F</sub> =60mA	
	Υ		0.3417				
Colour Temperature	ССТ		5600		К	I <sub>F</sub> =60mA	
Viewing Angle	2θ <sub>1/2</sub>		120		deg	I <sub>F</sub> =60mA	

<sup>1.</sup> Luminous flux ( $\Phi_V$ ) ±7%, Forward Voltage ( $V_F$ ) ±0.1V



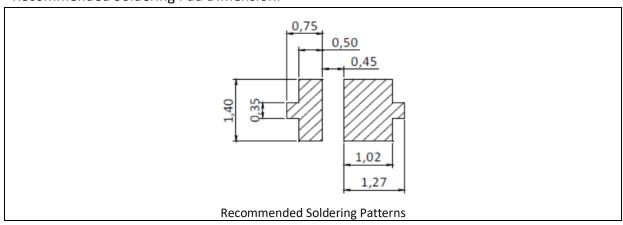
#### **OUTLINE DIMENSION:**

# Package Dimension:



- 1. All dimensions are in millimetre (mm).
- 2. Tolerance ±0.2mm, unless otherwise noted.

### **Recommended Soldering Pad Dimension:**



- 1. Dimensions are in millimetre (mm).
- 2. Tolerance ±0.1mm with angle tolerance ±0.5°.



# **BINNING GROUPS:**

# Forward Voltage Classifications (I<sub>F</sub> = 60mA):

Code	Min.	Max.	Unit	
B1	2.8	2.9		
C1	2.9	3.0	V	
D1	3.0	3.1		
E1	3.1	3.2		

### Luminous Flux Classifications ( $I_F = 60 \text{mA}$ ):

Code	Min.	Max.	Unit	
1E	18	20		
1F	20	22	lm	
1G	22	24		



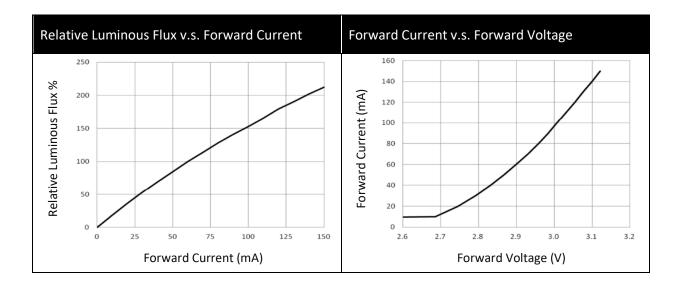
# **CIE CHROMATICITY DIAGRAM:**

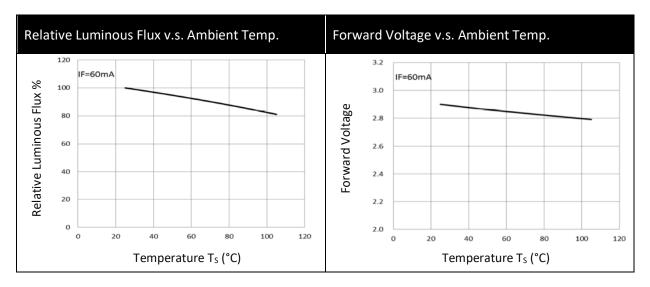
# Chromaticity Coordinates Classifications (I<sub>F</sub> = 60mA):

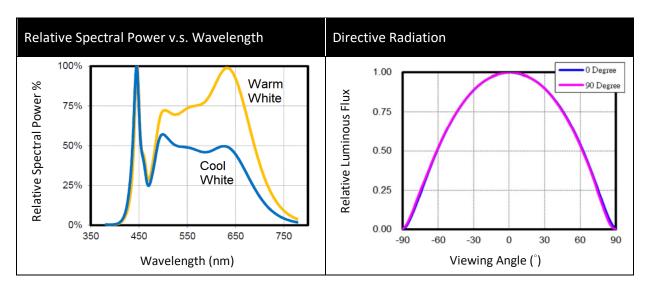
	Code	Centre		Radius		Angle
a / )		Х	Υ	а	b	Φ
D D	56SC5	0.3287	0.3417	0.011180	0.005500	58.35



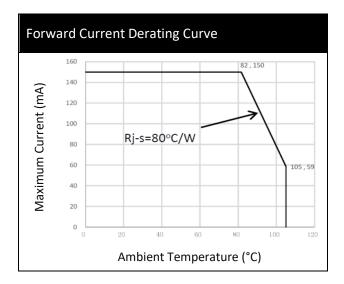
#### **ELECTRO-OPTICAL CHARACTERISTICS:**







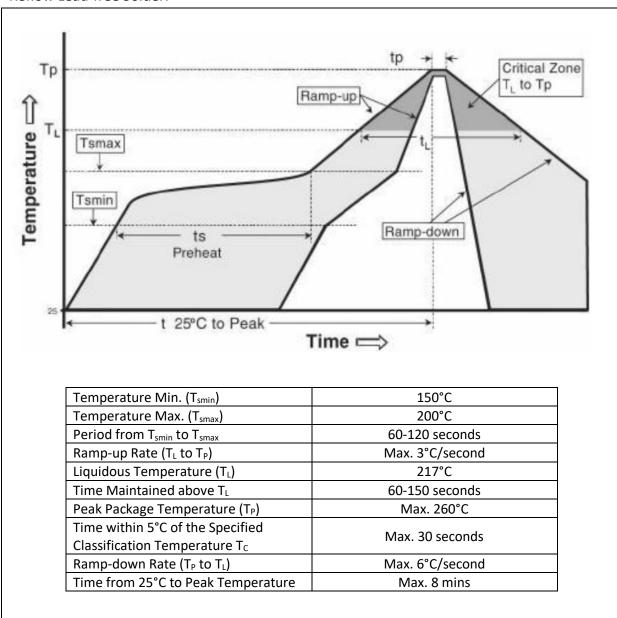






#### **RECOMMENDED SOLDERING PROFILE:**

#### Reflow Lead-free Solder:



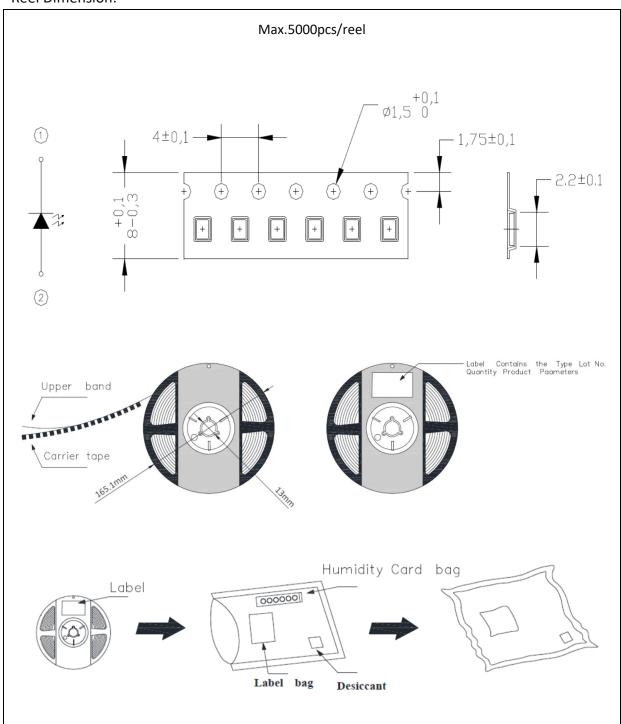
#### Note:

- 1. Maximum reflow soldering: 2 times.
- 2. Before, during, and after soldering, should not apply stress on the components and PCB board.
- 3. Recommended soldering temperature: 230°C. The maximum soldering temperature should be limited to 260°C for max. 10seconds.



# **PACKING SPECIFICATION:**

### Reel Dimension:





#### PRECAUTIONS OF USE:

#### Storage:

It is recommended to store the products in the following conditions:

• Humidity: 60% R.H. Max.

• Temperature: 5°C~30°C (41°F ~86°F).

Shelf life in sealed bag: 12 months at 5°C~30°C and <60% R.H.

Once the package is opened, the products should be used within a week. Otherwise, they should be kept in a damp-proof box with descanting agent <10% R.H. and apply baking before use.

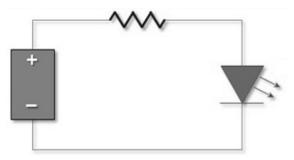
#### Baking:

It is recommended to bake the LED before soldering if the pack has been unsealed for longer than 24hrs. The suggested baking conditions are as followings:

• 60±5°C x 24hrs and <5%RH, taped / reel package.

It's normal to see slight color fading of carrier (light yellow) after baking in process.

#### **Testing Circuit:**



Must apply resistor(s) for protection (over current proof).

#### Cleaning:

Use alcohol-based cleaning solvents such as isopropyl alcohol to clean the LED carrier / package. Avoid putting any stress force directly on to the LED lens.

#### ESD (Electrostatic Discharge):

Static Electricity or power surge will damage the LED. Use of a conductive wrist band or anti-electrosatic glove is recommended when handing the LED all time. All devices, equipment, machinery, work tables, and storage racks must be properly grounded.

In the events of manual working in process, make sure the devices are well protected from ESD at any time.



# **REVISION RECORD:**

Version	Date	Summary of Revision
A1.0	18/05/2023	Datasheet set-up.